

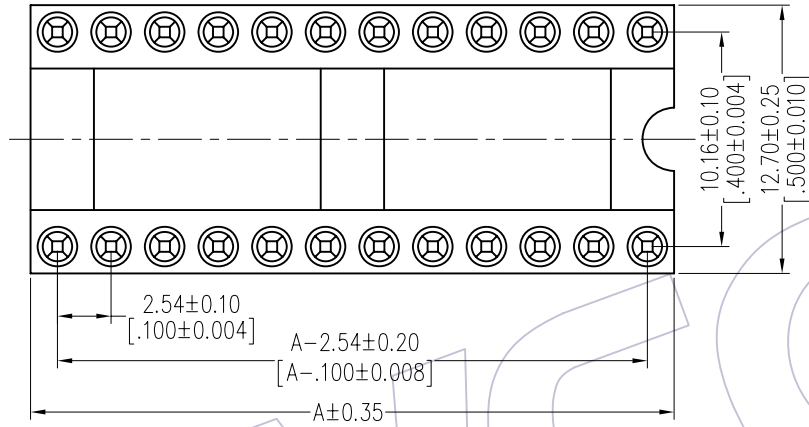
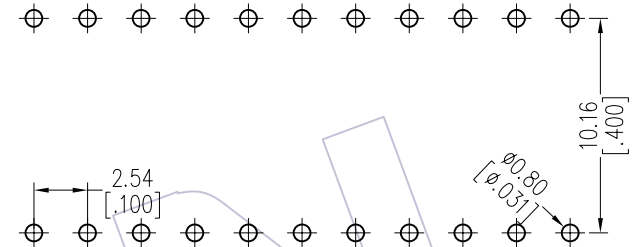
# HSF

**TECHNICAL SPECS:**

Current Rating: 1.0AMP  
 Contact Resistance: 10mΩ Max  
 Dielectric Strength: Min 1000VRMS  
 Mechanical Life: Min 100 cycles  
 Mating Pin: Ø0.40 to Ø0.56mm  
 Forces: (polished steel gauge Ø0.43mm)  
 Insertion: 200g Max/Pin, Withdrawal: 60g Min/Pin  
 Operation Temperature: -40°C to +105°C

Sleeve: Brass CuZn36Pb3(C36000), Sn over Ni  
 Contact Clip(4 finger): BeCu(C17200), Au or Sn over Ni  
 Insulator Material: PPS+30%G.F(UL94V-0)

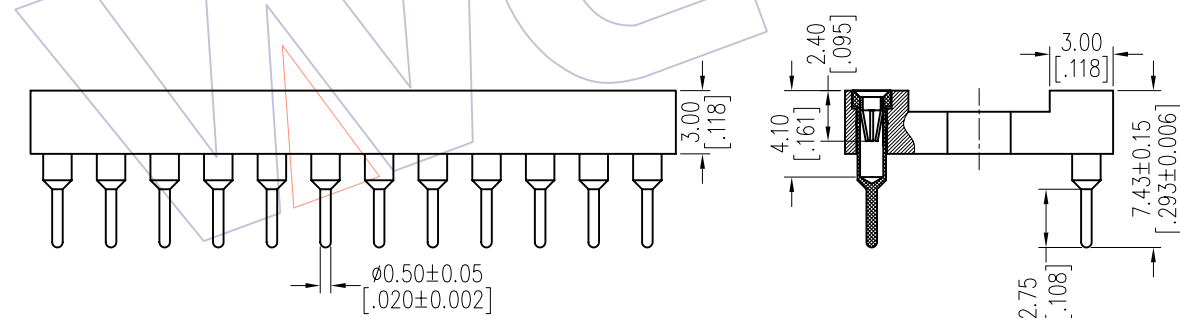
Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



## Ordering Information

7110-303 XX S XX 074 X 1

Row of Pitch 3=10.16mm	No. of Pin See tab	Contact Plating S0=Gold Flash/Tin S3=10u"Gold/Tin S4=15u"Gold/Tin S5=30u"Gold/Tin SN=Tin	Packing T=Tube A=Tray
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Dimensional & Ordering Information

NO. of Poles	Part No.	Dim
		A
20	7110-30320SXX074X1	25.40
22	7110-30322SXX074X1	27.94
24	7110-30324SXX074X1	30.48
28	7110-30328SXX074X1	35.56
32	7110-30332SXX074X1	40.64

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
				x.x ±0.40	JYHuang	2012/11/02	UNIT	mm	SEE TAB
				x.xx ±0.25	CHECK	DATE	SIZE	A4	TITLE: 2.54mm IC SOCKET 180° H=3.0 L=7.43 Row of Pitch 10.16
				x.xxx ±0.15	APPROVE	DATE	SHEET	1/1	Customer NO.
				Angle ± 3'			PROJ.		
				DIM TOL					